

ON Semiconductor®

FDN359AN N-Channel Logic Level PowerTrench[™] MOSFET

General Description

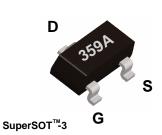
This N-Channel Logic Level MOSFET is produced using ON Semiconductor's advanced PowerTrench process that has been especially tailored to minimize on-state resistance and yet maintain superior switching performance.

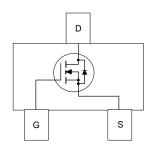
These devices are well suited for low voltage and battery powered applications where low in-line power loss and fast switching are required.

Features

- 2.7 A, 30 V. $R_{DS(ON)} = 0.046 \ \Omega \ @V_{GS} = 10 \ V$ $R_{DS(ON)} = 0.060 \ \Omega \ @V_{GS} = 4.5 \ V.$
- Very fast switching.
- Low gate charge (5nC typical).
- High power version of industry standard SOT-23 package. Identical pin out to SOT-23 with 30% higher power handling capability.

,	888. 898				
SOT-23	SuperSOT [™] -6	SuperSOT [™] -8	SO-8	SOT-223	SOIC-16





Absolute Maximum Ratings $T_{a} = 25^{\circ}C$ unless other wise noted

Symbol	Parameter	Ratings	Units
V _{DSS}	Drain-Source Voltage	30	V
V _{GSS}	Gate-Source Voltage	±20	V
D	Maximum Drain Current - Continuous (Note 1a)	2.7	А
	- Pulsed	15	
P _D Maxin	Maximum Power Dissipation (Note 1a)	0.5	W
	(Note 1b)	0.46	
Γ _J ,T _{stg}	Operating and Storage Temperature Range	-55 to 150	°C
THERMA	L CHARACTERISTICS		
R _{eja}	Thermal Resistance, Junction-to-Ambient (Note 1a)	250	°C/W
R _{euc}	Thermal Resistance, Junction-to-Case (Note 1)	75	°C/W

Symbol	Parameter	Conditions		Min	Тур	Max	Units
OFF CHAR	ACTERISTICS	·		•	•	•	
BV _{DSS}	Drain-Source Breakdown Voltage	$V_{GS} = 0 V, I_{D} = 250 \mu A$		30			V
$\Delta BV_{DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient	I_{D} = 250 µA, Referenced to	25 °C		23		mV/ °C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 24 V, V_{GS} = 0 V$				1	μA
			T _J = 55°C			10	μA
IGSSF	Gate - Body Leakage, Forward	$V_{GS} = 20 \text{ V}, V_{DS} = 0 \text{ V}$				100	nA
	Gate - Body Leakage, Reverse	$V_{GS} = -20 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$				-100	nA
	CTERISTICS (Note)						1
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$		1	1.6	3	V
$\Delta V_{GS(th)} / \Delta T_J$	Gate Threshold Voltage Temp. Coefficient	I_{D} = 250 μ A, Referenced to	$I_{\rm D}$ = 250 µA, Referenced to 25 °C		-4		mV/°C
R _{DS(ON)}	Static Drain-Source On-Resistance	$V_{GS} = 10 \text{ V}, I_{D} = 2.7 \text{ A}$			0.037	0.046	Ω
20(01)			T _J =125°C		0.055	0.075	
		$V_{GS} = 4.5 \text{ V}, I_{D} = 2.4 \text{ A}$			0.049	0.06	
I _{D(ON)}	On-State Drain Current	$V_{GS} = 10 \text{ V}, V_{DS} = 5 \text{ V}$		15			Α
g _{FS}	Forward Transconductance	$V_{DS} = 5 V, I_{D} = 2.7 A$			9.5		S
DYNAMIC C	HARACTERISTICS						
C _{iss}	Input Capacitance	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$ f = 1.0 MHz	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V},$		480		pF
C _{oss}	Output Capacitance	f = 1.0 MHz			120		pF
C _{rss}	Reverse Transfer Capacitance				45		pF
SWITCHING	CHARACTERISTICS (Note)						
t _{D(on)}	Turn - On Delay Time	$V_{DD} = 5 \text{ V}, \text{ I}_{D} = 1 \text{ A},$ $V_{GS} = 4.5 \text{ V}, \text{ R}_{GEN} = 6 \Omega$			6	12	ns
t,	Turn - On Rise Time				13	24	ns
t _{D(off)}	Turn - Off Delay Time				15	27	ns
t,	Turn - Off Fall Time				4	10	ns
Q	Total Gate Charge	$V_{DS} = 10 \text{ V}, \text{ I}_{D} = 2.7 \text{ A},$ $V_{GS} = 5 \text{ V}$			5	7	nC
Q _{gs}	Gate-Source Charge				1.4		nC
Q _{gd}	Gate-Drain Charge				1.6		nC
DRAIN-SOL	IRCE DIODE CHARACTERISTICS AND MA	AXIMUM RATINGS					
I _s	Maximum Continuous Drain-Source Diode Forward Current					0.42	А
V _{SD}	Drain-Source Diode Forward Voltage $V_{GS} = 0 V, I_S = 0.42 A$ (Note)				0.65	1.2	V

Note:

1. R_{tun} is the sum of the junction-to-case and case-to-ambient thermal resistance where the case thermal reference is defined as the solder mounting surface of the drain pins. R_{tuc} is guaranteed by design while R_{tuck} is determined by the user's board design.

Typical $\mathsf{R}_{_{BJA}}$ using the board layouts shown below on FR-4 PCB in a still air environment :



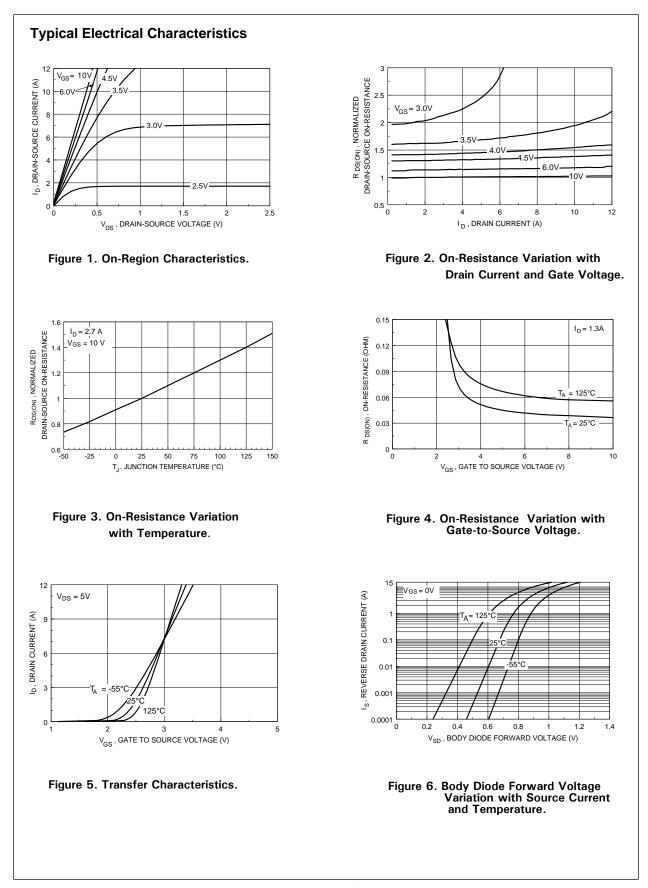
a. 250°C/W when mounted on a 0.02 in² pad of 2oz Cu.

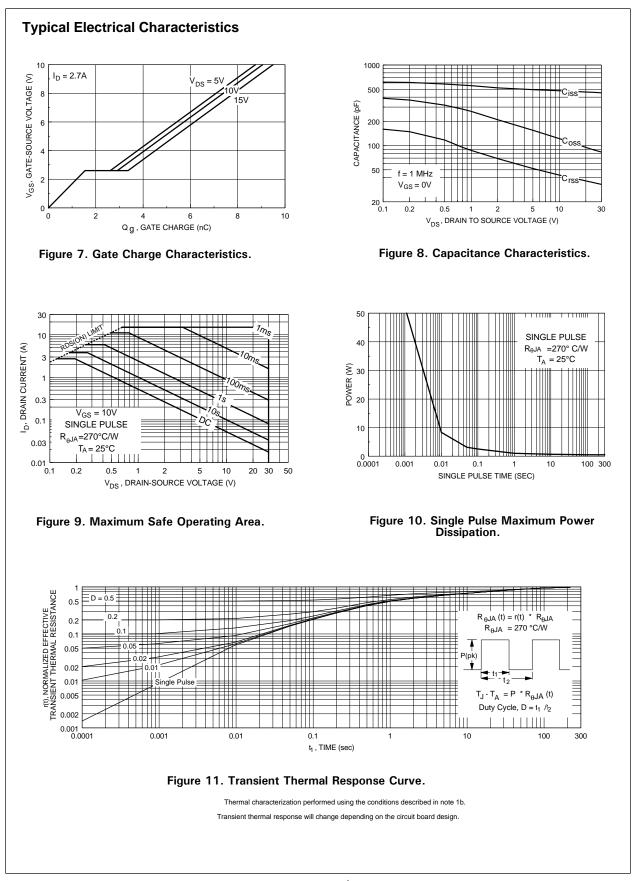
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b. 270°C/W when mounted on a minimum pad.

Scale 1 : 1 on letter size paper

2. Pulse Test: Pulse Width \leq 300µs, Duty Cycle \leq 2.0%.





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